

# HCF65S10D1

## eSiC Silicon Carbide Schottky Diode

650V, 10A

### Description

The 650V eSiC is an advanced Power Master Semiconductor's silicon carbide diode family. This technology combines the benefits of excellent low forward voltage and robustness. Consequently, the eSiC family is suitable for application requiring high power efficiency.

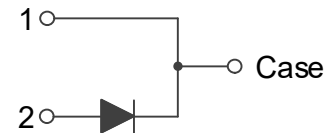
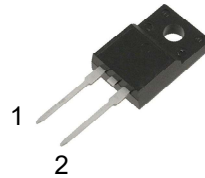
### Applications

- Power Factor Correction
- Industrial Power Supplies
- Solar Inverter, UPS

### Features

$V_{RRM}$	$I_F$	$T_{J,max}$	$Q_C$
650 V	10 A	175 °C	39 nC

- No reverse recovery current
- Low forward voltage
- 175°C Max junction temperature
- High surge current capability
- Switching behavior independent of temperature
- Pb-Free, Halogen Free and RoHS compliant



### Absolute Maximum Ratings ( $T_C = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Value	Unit	
$V_{RRM}$	Repetitive Peak Reverse Voltage	650	V	
$I_F$	Forward Current	$T_C=104^\circ\text{C}$ 10	A	
$I_{F,SM}$	Non-Repetitive Forward Surge Current	$T_C=25^\circ\text{C}, t_p=10\text{ ms}$	55	A
		$T_C=150^\circ\text{C}, t_p=10\text{ ms}$	46	A
$I_{F,Max}$	Non-Repetitive Peak Forward Current	$T_C=25^\circ\text{C}, t_p=10\text{ us}$	665	A
		$T_C=150^\circ\text{C}, t_p=10\text{ us}$	565	A
$I^2dt$ value	$\int i^2 dt$	$T_C=25^\circ\text{C}, t_p=10\text{ ms}$	15.1	$\text{A}^2\text{s}$
		$T_C=150^\circ\text{C}, t_p=10\text{ ms}$	10.6	$\text{A}^2\text{s}$
$P_{tot}$	Power Dissipation	$T_C=25^\circ\text{C}$ 38	W	
$T_J, T_{STG}$	Operating Junction and Storage Temperature	-55 to +175	$^\circ\text{C}$	

### Thermal Characteristics

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	4.0	$^\circ\text{C/W}$

## Package Marking and Ordering Information

Part Number	Top Marking	Package	Packing Method	Quantity
HCF65S10D1	HCF65S10D1	TO-220F-2L	Tube	50 units

## Electrical Characteristics (T<sub>C</sub> = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
V <sub>F</sub>	Forward Voltage	I <sub>F</sub> =10 A, T <sub>C</sub> =25°C		1.30	1.6	V
		I <sub>F</sub> =10 A, T <sub>C</sub> =175°C		1.45	-	
I <sub>R</sub>	Reverse Current	V <sub>R</sub> =650 V, T <sub>C</sub> =25°C		-	100	μA
		V <sub>R</sub> =650 V, T <sub>C</sub> =175°C		-	300	
Q <sub>C</sub>	Total Capacitive Charge	V <sub>R</sub> =400 V, T <sub>C</sub> =25°C		39		nC
C	Total Capacitance	V <sub>R</sub> =1 V, f=100 kHz		624		pF
		V <sub>R</sub> =400 V, f=100 kHz		59		
E <sub>C</sub>	Capacitance Stored Energy	V <sub>R</sub> =400 V, T <sub>C</sub> =25°C		5.7		μJ

Typical Performance Characteristics

Figure 1. Power Derating

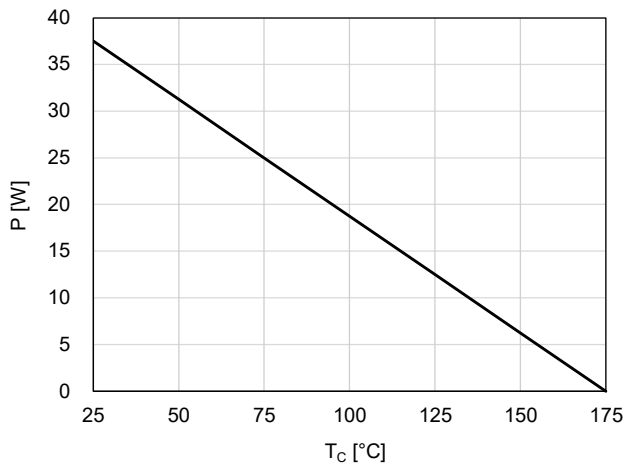


Figure 2. Current Derating

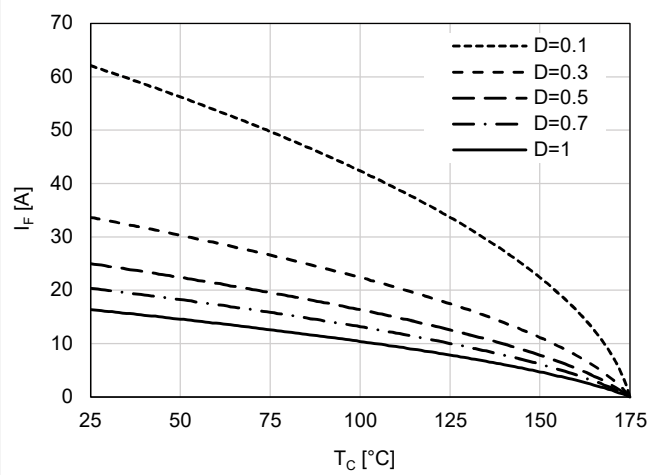


Figure 3. Forward Characteristics

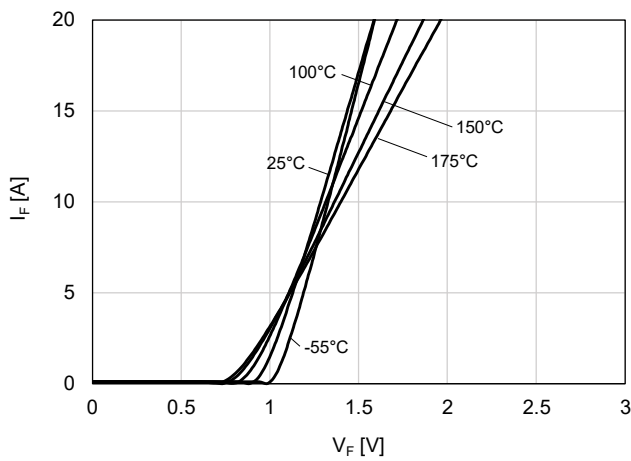


Figure 4. Reverse Characteristics

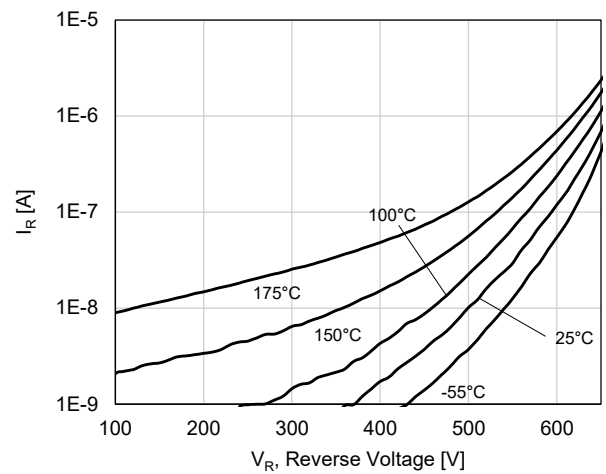


Figure 5. Capacitive Charge Characteristic

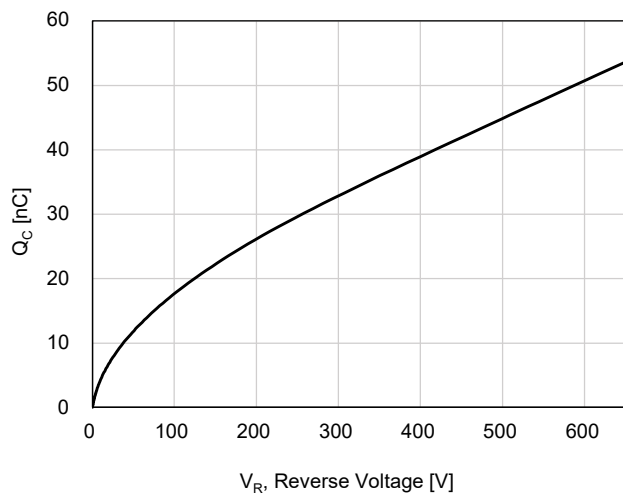
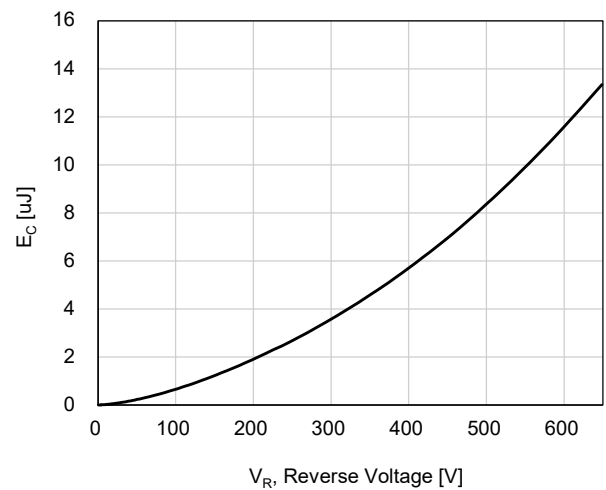


Figure 6. Capacitance Stored Energy



Typical Performance Characteristics

Figure 7. Capacitance Characteristic

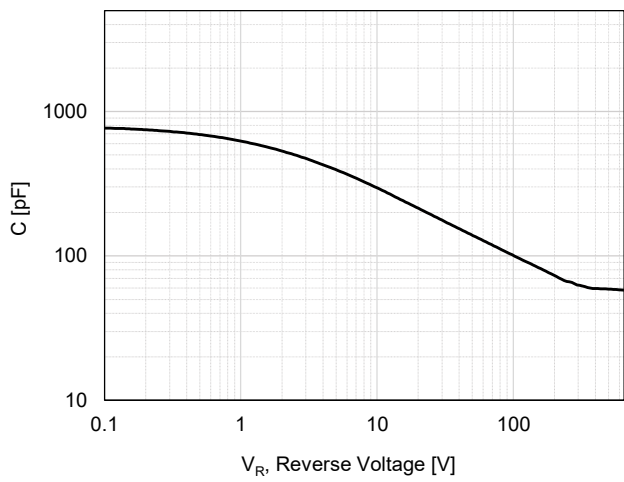
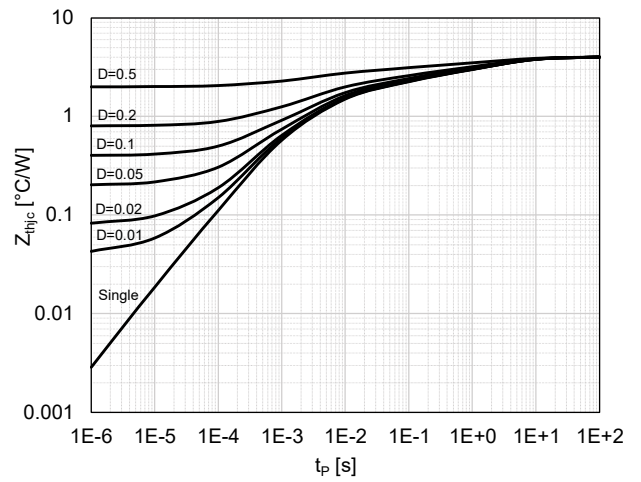
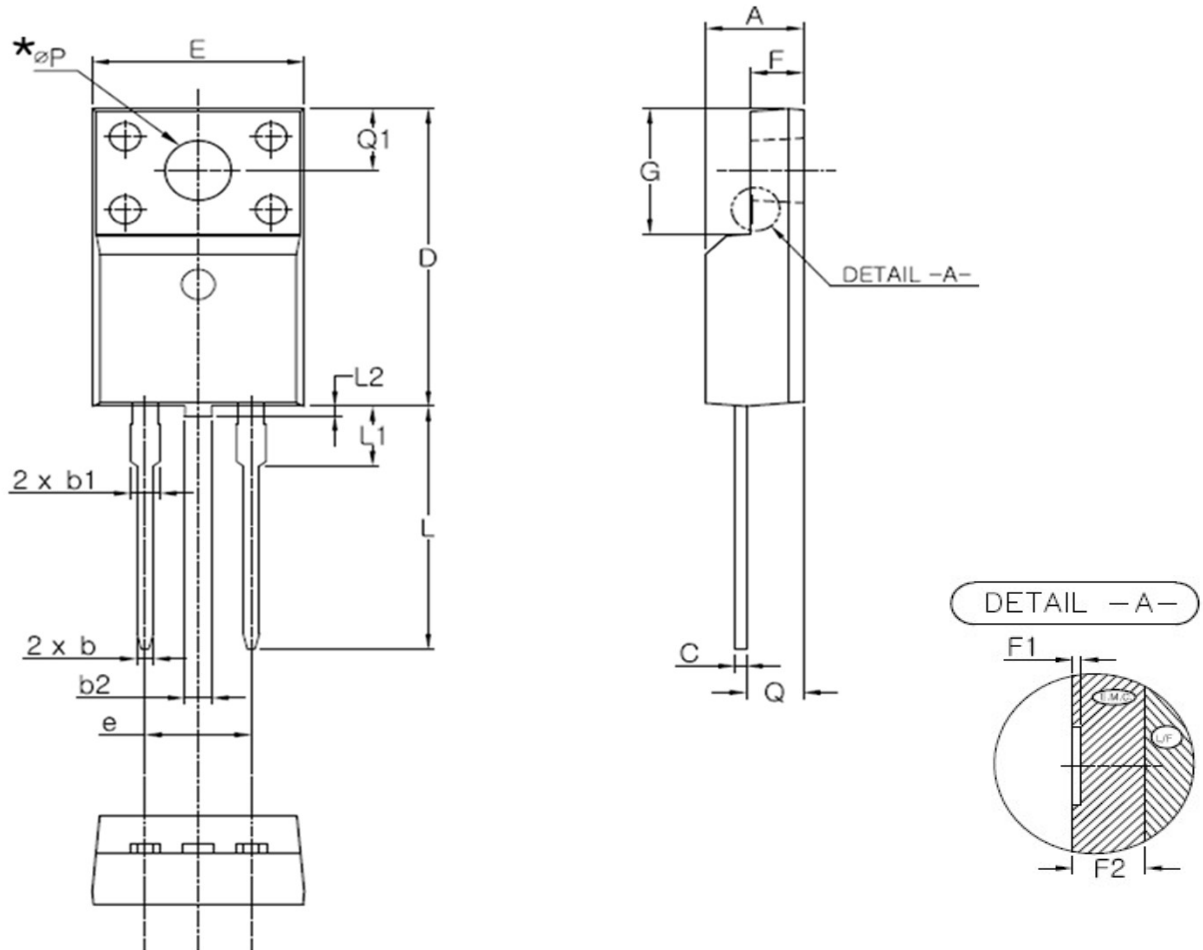


Figure 8. Transient Thermal Response Curve



## Package Outlines

# TO-220F-2L



SYMBOL	MIN	NOM	MAX
A	4.50	4.70	4.90
b	0.70	0.80	0.90
b1	1.33	1.40	1.47
b2	0.98	1.28	1.58
C	0.45	0.50	0.60
D	15.67	15.87	16.07
E	9.96	10.16	10.36
e	5.08 BSC		
F	2.34	2.54	2.74
F1	-	-	0.50
F2	(0.74)		
G	6.48	6.68	6.88
L	12.78	12.98	13.18
L1	2.98	3.18	3.38
L2	-	-	0.80
Q	2.56	2.76	2.96
Q1	3.10	3.30	3.50
★ øP	3.08	3.18	3.28

\* Dimensions in millimeters